

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: April 30, 2010  
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80154(302728)

Docket No.: 80154(302728)  
(PATENT)**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Takashi Yamaguchi et al.

Application No.: 10/539,884

Confirmation No.: 6471

Filed: June 16, 2005

Art Unit: 1791

For: COMPOSITE OF ALUMINUM MATERIAL  
AND SYNTHETIC RESIN MOLDING AND  
PROCESS FOR PRODUCING THE SAME

Examiner: D. N. Bodawala

INCORRECT: /DB/

**RESPONSE TO FINAL ACTION UNDER 37 C.F.R. 1.116**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated February 1, 2010, Applicant respectfully requests that the above-identified patent application be reconsidered in view of the remarks which follow, that each of the presently pending claims be allowed, and that the application be passed to issue.

**Remarks/Arguments** begin on page 2 of this paper.